

# Certificate

# OpenStage Ready

The connectivity of

**Konftel 60W**

made by the company

**Konftel GmbH**

at the integrated headset interface  
(wired and Bluetooth) of

**OpenStage SIP / HFA / TDM**

has been certified Siemens HiPath Ready  
Application in accordance with the test report  
dated 2009-12-04 conforming to DIN EN ISO 9001

This certificate is only valid in conjunction with the full test  
report and the notes contained therein.

Siemens Enterprise Communications GmbH & Co. KG  
Munich, 2009-12-04



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**SIEMENS**